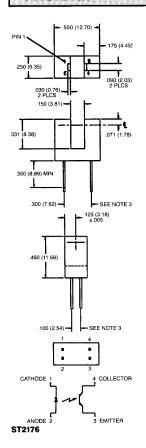


## **SLOTTED OPTICAL SWITCH**

# **QVE11233**

#### **PACKAGE DIMENSIONS**



#### NOTES:

- 1. DIMENSIONS ARE IN INCHES (mm).
- 2. TOLERANCE IS ±.010 (.25)
  UNLESS OTHERWISE SPECIFIED.
- 3. THIS DIMENSION IS CONTROLLED AT THE HOUSING SURFACE.

### DESCRIPTION

The QVE11233 is designed to allow the user maximum flexibility in applications. Each switch consists of an infrared emitting diode facing an NPN phototransistor across a .150" (3.81 mm) gap.

#### FEATURES

- Lead spacing .300".
- Gap width of .150".
- Printed circuit board mounting.
- 2 mm aperture width.



### **SLOTTED OPTICAL SWITCH**

-40°C to + 85°0 -40°C to + 85°0	Storage Temperature  Operating Temperature  Soldering:
240°C for 5 sec. (2.3	Lead Temperature (Iron)
	Lead Temperature (Flow)
	INPUT DIODE
	Continuous Forward Current
	Reverse Voltage
100 mW	Power Dissipation
	OUTPUT TRANSISTOR
	Collector-Emitter Voltage
5.0 Vo	Emitter-Collector Voltage
	Collector-Emitter Voltage Emitter-Collector Voltage Power Dissipation

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
INPUT DIODE						
Forward voltage	$V_{\scriptscriptstyle F}$	_		1.70	٧	$I_F = 20 \text{ mA}$
Reverse Leakage Current	i <sub>B</sub>			100	μΑ	$V_{R} = 2.0 \text{ V}$
OUTPUT TRANSISTOR						
Emitter-Collector Breakdown	$BV_{ECO}$	5			٧	$I_E = 100 \ \mu A, Ee = 0$
Collector-Emitter Breakdown	BV <sub>CEO</sub>	30		_	٧	$I_c = 1.0 \text{ mA}, Ee = 0$
Collector-Emitter Leakage	I <sub>CEO</sub>	_		100	nA	V <sub>CE</sub> = 10.0 V, Ee = 0
COUPLED						
On-State Collector Current	I <sub>C(ON)</sub>	0.50		_	mA	$I_F = 20$ mA, $V_{CE} = 5$ V
Saturation Voltage	V <sub>CE(SAT)</sub>	_		0.40	٧	$I_F = 20 \text{ mA}, I_C = 0.25 \text{ m}$

#### NOTES

- 1. Derate power dissipation linearly 1.67 mW/°C above 25°C.
- Befale power dissipation interactly 1.07 mW 6 above 25 c.
   RMA flux is recommended.
   Methanol or Isopropyl alcohols are recommended as cleaning agents.
   Soldering iron tip 1/6" (1.6 mm) from housing.



## SLOTTED OPTICAL SWITCH

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.